

Silicon Carbide Power MOSFET E-Series Automotive N-Channel Enhancement Mode

Features

- 3rd generation SiC MOSFET technology
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q,,)
- Halogen free, RoHS compliant
- Automotive Qualified (AEC-Q101) and PPAP Capable

Benefits

- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

Applications

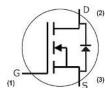
- EV Battery Chargers
- High Voltage DC/DC Converters

Package









Part Number	Package	Marking
E3M0060065D	TO-247-3L	E3M0060065D

Maximum Ratings ($T_c = 25$ °C unless otherwise specified)

Symbol	Parameter	Value	Unit	Note	
V_{DSmax}	Drain - Source Voltage		650	V	
V_{GSmax}	Gate - Source Voltage		-8/+19	V	Note: 1
	Continuous Dunin Comment V. 15 V.	T _C = 25°C	37		Fig. 19
I _D	Continuous Drain Current, V _{GS} = 15 V		26		Note: 2
I _{D(pulse)}	Pulsed Drain Current, Pulse width t _p limited by T _{jmax}	99	А	Fig. 22	
P _D	Power Dissipation, $T_c = 25^{\circ}C$, $T_J = 175^{\circ}C$	131	W	Fig. 20 Note: 2	
T_{J},T_{stg}	Operating Junction and Storage Temperature			°C	
T _L	Solder Temperature, 1.6mm (0.063") from case for 10s			°C	
M _d	Mounting Torque , M3 or 6-32 screw	1 8.8	Nm Ibf-in		

Note (1): Recommended turn off / turn on gate voltage V_{GS} - 4V...0V / +15V

Note (2): Verified by design

Electrical Characteristics $(T_c = 25^{\circ}C \text{ unless otherwise specified})$

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	Note
V _{(BR)DSS}	Drain-Source Breakdown Voltage	650			٧	$V_{GS} = 0 \text{ V, } I_D = 100 \mu\text{A}$	
V	V _{GS(th)} Gate Threshold Voltage		2.8	3.6	V	$V_{DS} = V_{GS}$, $I_D = 3.6 \text{ mA}$	Fig. 11
V GS(th)	Gate Theshold Voltage		2.2		V	$V_{DS} = V_{GS}$, $I_D = 3.6 \text{ mA}$, $T_J = 175 ^{\circ}\text{C}$	Fig. 11
I _{DSS}	Zero Gate Voltage Drain Current		1	50	μΑ	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$	
I _{GSS}	Gate-Source Leakage Current		10	250	nA	$V_{GS} = 15 \text{ V}, V_{DS} = 0 \text{ V}$	
R _{DS(on)}	Drain-Source On-State Resistance		60	79	mΩ	$V_{GS} = 15 \text{ V}, I_D = 13.2 \text{ A}$	Fig. 4,
D2(on)	Jan Journe on State Nesistance	\perp	83	<u> </u>		V _{GS} = 15 V, I _D = 13.2 A, T _J = 175°C	5, 6
g fs	Transconductance		9	ļ	S	V_{DS} = 20 V, I_{DS} = 13.2 A	Fig. 7
J.		\perp	9	ļ		V _{DS} = 20 V, I _{DS} = 13.2 A, T _J = 175°C	"
C _{iss}	Input Capacitance		1170				
Coss	Output Capacitance		72		рF	$V_{GS} = 0 \text{ V}, V_{DS} = 0 \text{V to } 600 \text{ V}$	Fig. 17, 18
C _{rss}	Reverse Transfer Capacitance		6			F = 1 Mhz	
E _{oss}	Coss Stored Energy		14		μЈ	V _{AC} = 25 mV	Fig. 16
C _{o(er)}	Effective Output Capacitance (Energy Related)		85		рF		Note: 3
C _{o(tr)}	Effective Output Capacitance (Time Related)		122		рF	$V_{GS} = 0 \text{ V}, V_{DS} = 0400 \text{ V}$	
E _{on}	Turn-On Switching Energy (External Diode)		126			$V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_D = 13.2 \text{A},$	Fig. 26
E _{OFF}	Turn Off Switching Energy (External Diode)		25		μЈ	$R_{G(ext)} = 2.5 \Omega$, L= 135 μH, $T_J = 175$ °C FWD = External SiC DIODE	
E _{on}	Turn-On Switching Energy (Body Diode FWD)		169			$V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_D = 13.2 \text{A},$	
E _{OFF}	Turn-Off Switching Energy (Body Diode FWD)		23		μЈ	$R_{G(ext)} = 2.5 \Omega$, L= 135 μH, $T_J = 175$ °C FWD = Internal Body Diode	Fig. 26
t _{d(on)}	Turn-On Delay Time		10				
t _r	Rise Time		33			$V_{DD} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$ $I_D = 13.2 \text{ A}, R_{G(ext)} = 2.5 \Omega,$	
t _{d(off)}	Turn-Off Delay Time		17		ns	Timing relative to V _{DS}	Fig. 27
t _f	Fall Time		8			inductive load	
$R_{G(int)}$	Internal Gate Resistance		4		Ω	f = 1 MHz, V _{AC} = 25 mV	
Q_{gs}	Gate to Source Charge		16			$V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$	Fig. 12
Q_{gd}	Gate to Drain Charge		13]	nC	I _D = 13.2 A	
Q_g	Total Gate Charge		46			Per IEC60747-8-4 pg 21	

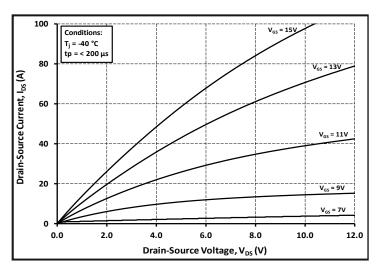
Note (3): $C_{O(er)}$, a lumped capacitance that gives same stored energy as Coss while Vds is rising from 0 to 400V $C_{O(tr)}$, a lumped capacitance that gives same charging time as Coss while Vds is rising from 0 to 400V

Reverse Diode Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
V				V	$V_{GS} = -4 \text{ V, } I_{SD} = 6.6 \text{ A, } T_{J} = 25 \text{ °C}$	Fig. 8,
V _{SD}	Diode Forward Voltage	4.1		V	$V_{GS} = -4 \text{ V, } I_{SD} = 6.6 \text{ A, } T_{J} = 175 \text{ °C}$	9, 10
Is	Continuous Diode Forward Current		23	Α	$V_{GS} = -4 \text{ V}, T_C = 25^{\circ}\text{C}$	
I _{S, pulse}	Diode pulse Current		99	Α	$V_{GS} = -4 \text{ V}$, pulse width t_p limited by T_{jmax}	
t _{rr}	Reverse Recover time	23		ns		
Q _{rr}	Reverse Recovery Charge	108		nC	$V_{cs} = -4 \text{ V, } I_{sp} = 13.2 \text{ A, } V_{R} = 400 \text{ V}$ dif/dt = 1720 A/ μ s, $T_{J} = 175 ^{\circ}\text{C}$	
I _{rrm}	Peak Reverse Recovery Current	8		А		
t _{rr}	Reverse Recover time	30		ns		
Q _{rr}	Reverse Recovery Charge	97		nC	$V_{GS} = -4 \text{ V}, I_{SD} = 13.2 \text{ A}, V_{R} = 400 \text{ V}$ dif/dt = 790 A/\mus, T ₁ = 175 °C	
I	Peak Reverse Recovery Current	6		А		

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
$R_{\theta JC}$	Thermal Resistance from Junction to Case	1.02	1.14	°C/W		Fig. 21



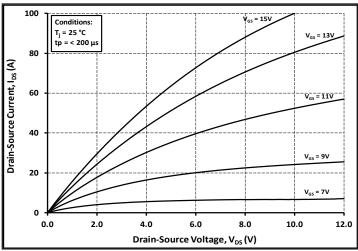
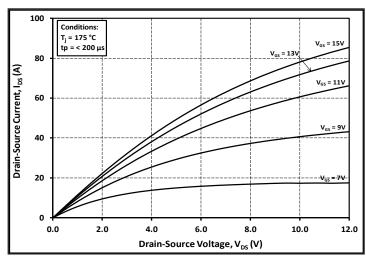


Figure 1. Output Characteristics T_J = -40 °C





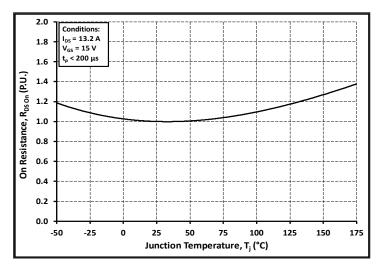
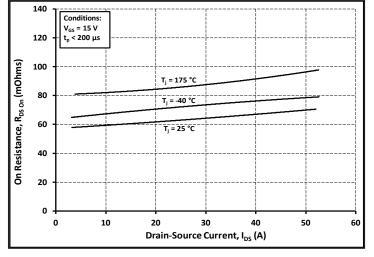


Figure 3. Output Characteristics T_J = 175 °C

Figure 4. Normalized On-Resistance vs. Temperature



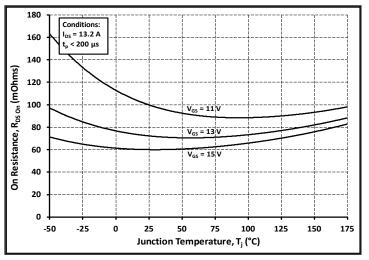
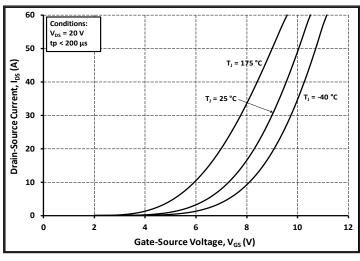


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

Figure 6. On-Resistance vs. Temperature For Various Gate Voltage



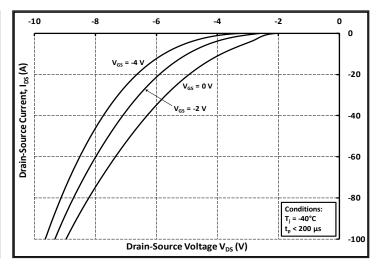
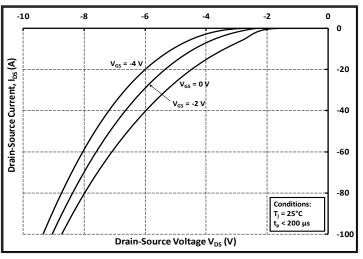


Figure 7. Transfer Characteristic for Various Junction Temperatures

Figure 8. Body Diode Characteristic at -40 °C



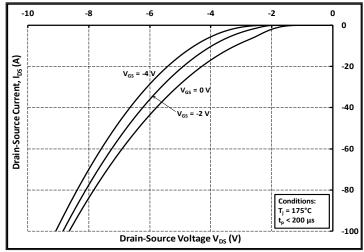
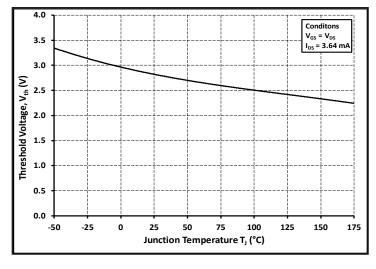


Figure 9. Body Diode Characteristic at 25 °C

Figure 10. Body Diode Characteristic at 175 °C



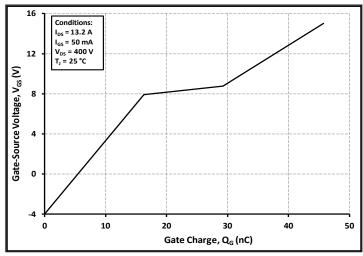


Figure 11. Threshold Voltage vs. Temperature

Figure 12. Gate Charge Characteristics

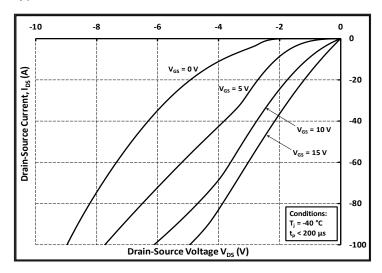


Figure 13. 3rd Quadrant Characteristic at -40 °C

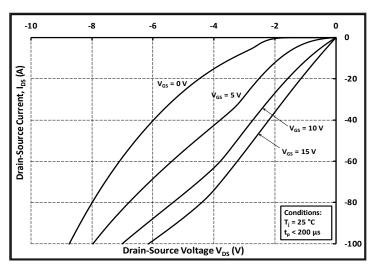


Figure 14. 3rd Quadrant Characteristic at 25 °C

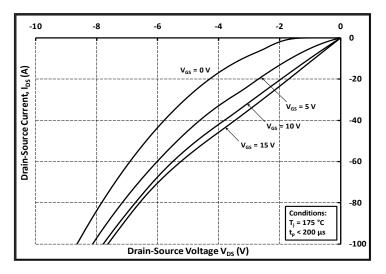


Figure 15. 3rd Quadrant Characteristic at 175 °C

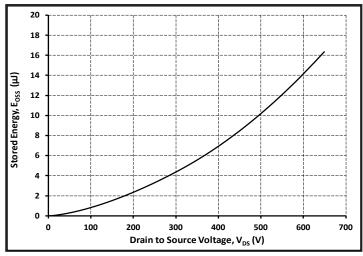


Figure 16. Output Capacitor Stored Energy

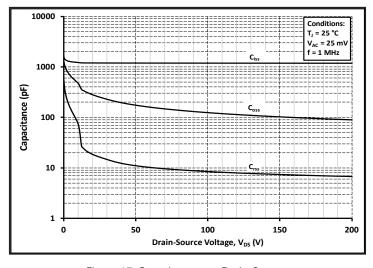


Figure 17. Capacitances vs. Drain-Source Voltage (0 - 200V)

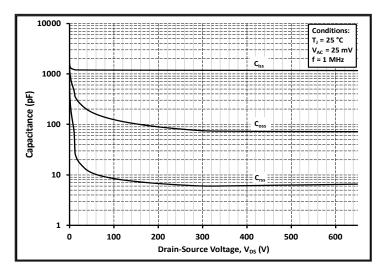
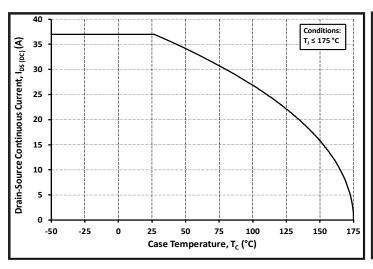


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 650V)



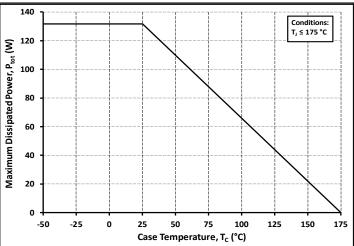
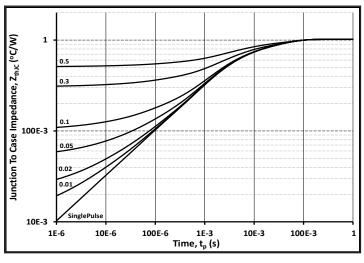


Figure 19. Continuous Drain Current Derating vs.

Case Temperature

Figure 20. Maximum Power Dissipation Derating vs. Case Temperature



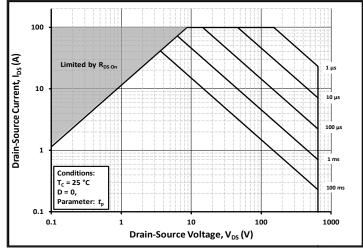
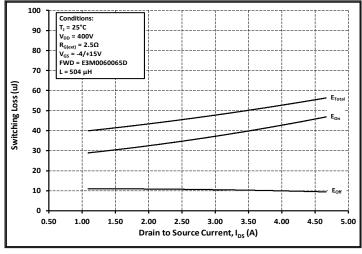


Figure 21. Transient Thermal Impedance (Junction - Case)

Figure 22. Safe Operating Area



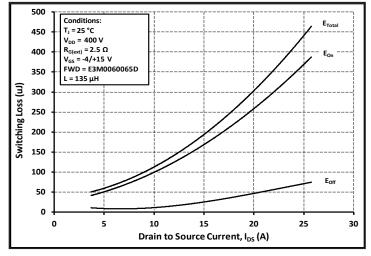


Figure 23. Clamped Inductive Switching Energy vs. Low Drain Current ($V_{DD} = 400V$)

Figure 24. Clamped Inductive Switching Energy vs. High Drain Current ($V_{DD} = 400V$)

Typical Performance

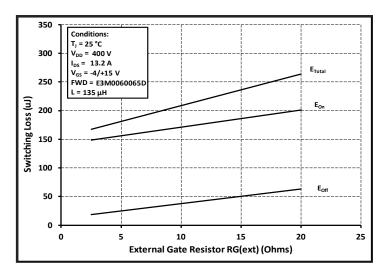


Figure 25. Clamped Inductive Switching Energy vs. $R_{G(ext)}$

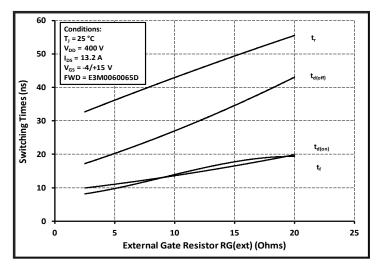
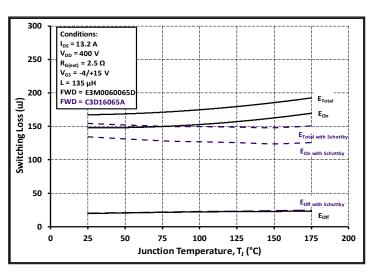


Figure 27. Switching Times vs. $R_{G(ext)}$



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Figure 26. Clamped Inductive Switching Energy vs.
Temperature

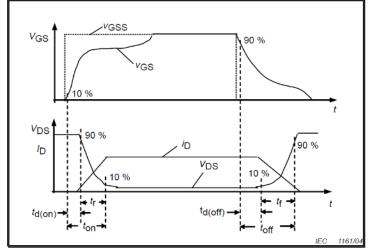


Figure 28. Switching Times Definition

Test Circuit Schematic

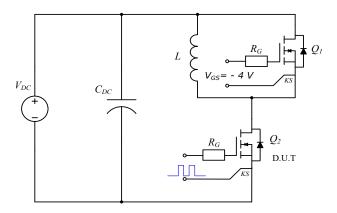
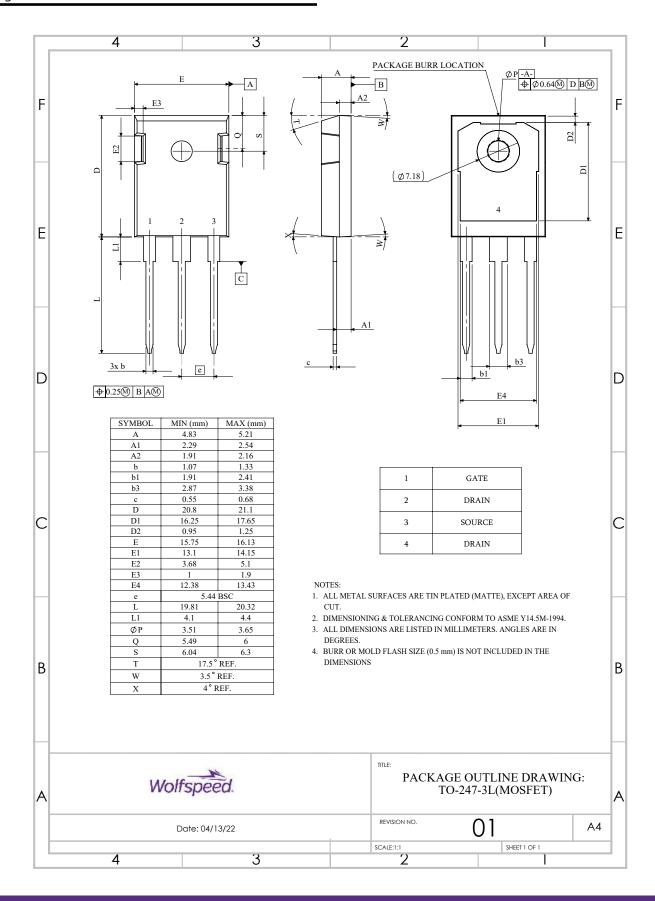


Figure 29. Clamped Inductive Switching Waveform Test Circuit

Package Dimensions



Recommended Solder Pad Layout



Revision history

Document Version	Date of release	Descriptiion of changes
1.0	June-2022	Initial datasheet

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